

Ex enclosure made of stainless steel, IP66. Empty enclosure prepared for installation of the ET 200iSP. II 2D Ex tb IIIC Db Size (WxHxD): 950x450x230, for max. 24 iSP modules (EM/IM). Cable entries: 2x M32 power supply, 4x M20 bus cables and 66x M16 (5-10 mm) for signals in 3 rows, version in nickel-plated brass. Ambient operating temperature -40...+70 °C.

Further information

Industry Online Support (Manuals, Catalogs, Certificates, FAQ, ...)

<https://support.industry.siemens.com/cs/products?mfn=ps&lc=en-WW>

Industry Mall (Online ordering system)

<https://mall.industry.siemens.com>

